

RAMPAGE II GENE Memory Qualified Vendors List (QVL)

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Vendor	Part No.	Type	Size	SS/DS	Chip Brand	Chip NO.	Timing Dimm(Bios)	Voltage	DIMM socket support (Optional)			
									A*	B*	C*	D*
CORSAIR	CM3X1024-1066C7	DDR3 1067	1024MB	DS	N/A	Heat-Sink Package	7	1.1	•	•	•	•
Crucial	CT12864BA1067.8SFD	DDR3 1067	1024MB	SS	MICRON	D9JNL	7		•	•	•	•
Crucial	CT25664BA1067.16SFD	DDR3 1067	2048MB	DS	MICRON	D9JNL	7		•	•	•	•
ELPIDA	EJB10UE8BAW0-AE-E	DDR3 1067	1024MB	SS	ELPIDA	J1108BABG-DJ-E	7(1066-7-7-7-20)		•	•	•	•
ELPIDA	EJB11RD8BAFA-AE-E	DDR3 1067	1024MB	DS	ELPIDA	J5308BASE-AC-E(ECC)	7		•	•	•	•
ELPIDA	EJB11UD8BAFA-AG-E	DDR3 1067	1024MB	DS	ELPIDA	J5308BASE-AC-E	8		•	•	•	
ELPIDA	EJB21UE8BAW0-AE-E	DDR3 1067	2048MB	DS	ELPIDA	J1108BABG-DJ-E	7(1066-7-7-7-20)		•	•	•	•
Hynix	HMT112U6AFP8C-G7N0	DDR3 1067	1024MB	SS	HYNIX	H5TQ1G83AFCPG7C	7		•	•	•	•
Hynix	HYMT112U64ZNF8-G7	DDR3 1067	1024MB	SS	HYNIX	HY5TQ1G831ZNFP-G7	7		•	•	•	
Hynix	HMT125U6AFP8C-G7N0	DDR3 1067	2048MB	DS	HYNIX	H5TQ1G83AFCPG7C	7		•	•	•	•
Hynix	HYMT125U64ZNF8-G7	DDR3 1067	2048MB	DS	HYNIX	HY5TQ1G831ZNFP-G7	7		•	•	•	
KINGSTON	KVR1066D3N7/1G	DDR3 1067	1024MB	SS	ELPIDA	J1108BABG-DJ-E	1066-7-7-7-20	1.5	•	•	•	•
KINGSTON	KVR1066D3N7/2G	DDR3 1067	2048MB	DS	ELPIDA	J1108BABG-DJ-E	1066-7-7-7-20	1.5	•	•	•	•
MICRON	MT8JTF12864AY-1G1D1	DDR3 1067	1024MB	SS	MICRON	7VD22	7		•	•	•	•
MICRON	MT16JTF25664AY-1G1D1	DDR3 1067	2048MB	DS	MICRON	7VD22	7		•	•	•	•
SAMSUNG	M378B5273BH1-CF8	DDR3 1067	4096MB	DS	SAMSUNG	K4B2G0846B-HCF8	8(7-7-7-20)	1.5	•	•	•	•
Transcend	TS256MLK64V1U	DDR3 1067	2048MB	DS	ELPIDA	J1108BABG-AE-E	7(1066-7-7-7-20)		•	•	•	•
Asint	SLY3128M8-EAE	DDR3 1067	1024MB	SS	Asint	DDRIII1208-AE	(7-7-7-20)		•	•	•	•
Asint	SLZ3128M8-EAE	DDR3 1067	2048MB	DS	Asint	DDRIII1208-AE	(7-7-7-20)		•	•	•	•
Elixir	M2F2G64CB8HAN4-BE	DDR3 1067	2048MB	DS	Elixir	N2CB1G80AN-BE	7		•	•	•	
WINTEC	3DU3191A-10	DDR3 1067	1024MB	DS	Qimonda	IDSH51-03A1F1C-10F	7		•	•	•	

6 Dimm :

- A*: Supports [two \(2\) modules](#) inserted into slot A1 and B1 as one pair of Dual-channel memory configuration
- B*: Supports [three \(3\) modules](#) inserted into the orange slots (A1, B1 and C1) as one set of Triple-channel memory configuration
- C*: Supports [four \(4\) modules](#) inserted into the orange slots (A1, B1 and C1) and the black slot A2 as one set of Triple-channel memory configuration
- D*: Supports [six \(6\) modules](#) inserted into both the orange slots and the black slots as two set of Triple-channel memory configuration.

Note: 請按此鉗

-When installing total memory of 4GB capacity or more, Windows 32-bit operation system may only recognize less than 3GB. Hence, a total installed memory of less than 3GB is recommended.

-It is recommended to install the memory modules from the slots for better overclocking capability.

-The default DIMM frequency depends on its Serial Presence Detect (SPD), which is the standard way of accessing information from a memory module. Under the default state, some memory modules for overclocking may operate at a lower frequency than the vendor-marked value.